



Customer Information Notification

201903027I

Issue Date: 29-Mar-2019

Effective Date: 30-Mar-2019

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QUALITY

Management Summary

This CIN is to provide notification of the burn in expansion of the TPMS 7x7 product line from the current KES (Taiwan) facility into the ASECL (Taiwan) burn in facility.

Change Category

| | | | | |
|--|---|--|--|---|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input checked="" type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input checked="" type="checkbox"/> Test Process | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input checked="" type="checkbox"/> Test Equipment | <input type="checkbox"/> Electrical spec./Test coverage |
| <input type="checkbox"/> Firmware | <input type="checkbox"/> Other | | | |

TPMS 7x7 Product
(FXTH8700 Family)
Burn In Expansion

Description

Notification of the burn in expansion of the TPMS 7x7 product line from the current KES (Taiwan) burn in facility into the ASECL (Taiwan) burn in facility. This change affects the FXTH8700 product family tested in ASECL (Taiwan).

Burn in is currently outsourced from ASECL facility to the KES (Taiwan) facility. KES (Taiwan) acts as a subcontractor to ASECL. This expansion is designed to bring equivalent burn in capability into ASECL to improve supply assurance.

Reason

ASECL is expanding burn in capabilities to improve the supply assurance for the end customers.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

Existing inventory will be shipped until depleted

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Jason Diefenbacher
Position Backend Operations Manager, Pressure Products
e-mail address Jason.Diefenbacher@NXP.COM

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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| Changed Orderable Part# | Changed Part 12NC | Changed Part Number | Changed Part Description | Package Outline | Package Name | Status | New Orderable Part# | New part 12NC | New Part number | New part description | Product Line | Notes |
|-------------------------|-------------------|---------------------|--------------------------|-----------------|--------------|--------|---------------------|---------------|-----------------|--------------------------|------------------|------------------|
| FXTH8709116T1 | 935315035528 | FXTH8709116T1 | TPMS 7x7 900kPa X&Z axis | SOT1575-1 | HQFN24 | RFS | FXTH8709116T1 | 935315035528 | FXTH8709116T1 | TPMS 7x7 900kPa X&Z axis | Sensors Pressure | LAUSITZ |
| FXTH870911DT1 | 935311936528 | FXTH870911DT1 | TPMS 7x7 900kPa X&Z axis | SOT1575-1 | HQFN24 | RFS | FXTH870911DT1 | 935311936528 | FXTH870911DT1 | TPMS 7x7 900kPa X&Z axis | Sensors Pressure | LAUSITZ |
| FXTH871511DT1 | 935312081528 | FXTH871511DT1 | TPMS 7x7 1500kPa XZ Axis | SOT1575-1 | HQFN24 | RFS | FXTH871511DT1 | 935312081528 | FXTH871511DT1 | TPMS 7x7 1500kPa XZ Axis | Sensors Pressure | LAUSITZ 1500 KPA |